

## 30V N-Channel MOSFET

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
30V	30m $\Omega$ @10V	5.8A
	42m $\Omega$ @4.5V	

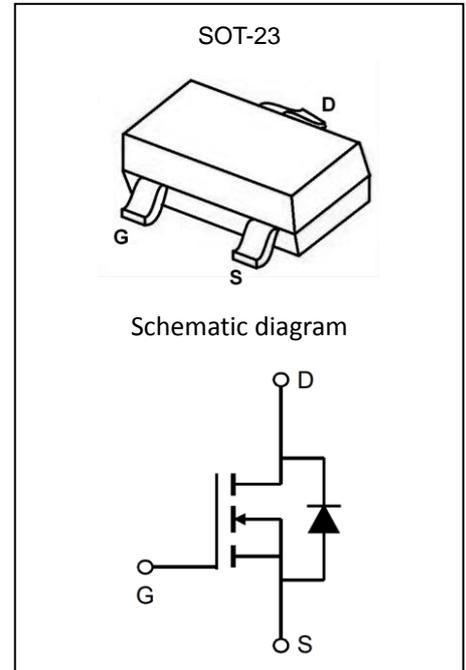
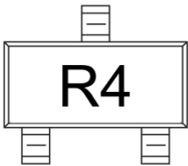
## Feature

- TrenchFET Power MOSFET
- Excellent  $R_{DS(on)}$  and Low Gate Charge
- AEC-Q101 qualified (Automotive grade with suffix "Q".)
- Exsemi technology

## Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch
- AEC-Q101 qualified
- Exsemi technology

## MARKING:

ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	5.8	A
Pulsed Drain Current	$I_{DM}$	30	A
Power Dissipation*	$P_D$	0.35	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	357	$^\circ\text{C/W}$
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55~ +150	$^\circ\text{C}$

\* Repetitive rating : Pulse width limited by maximum junction temperature.

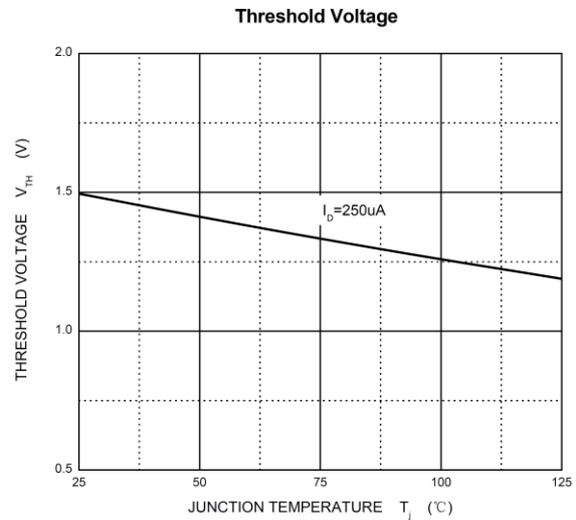
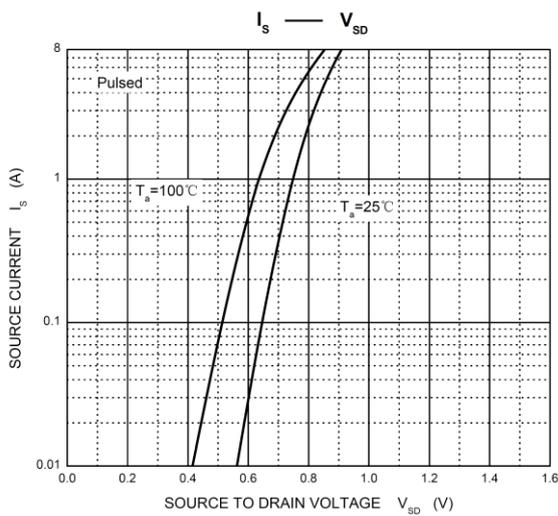
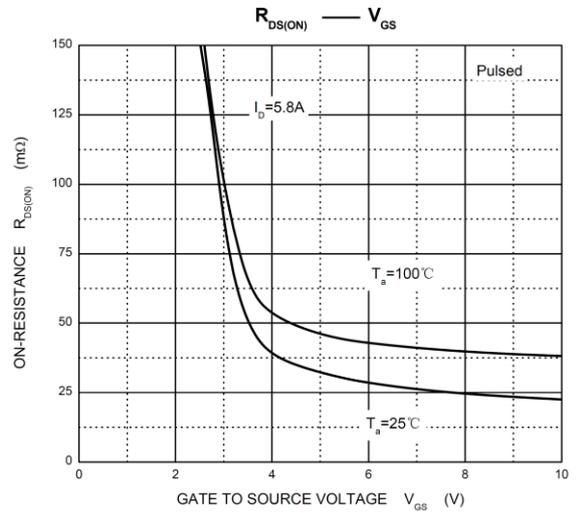
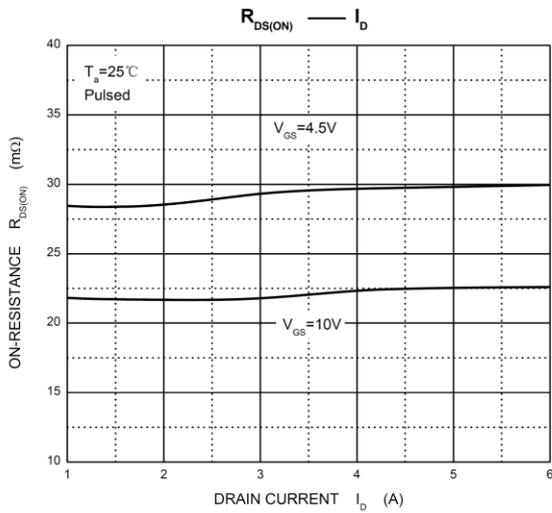
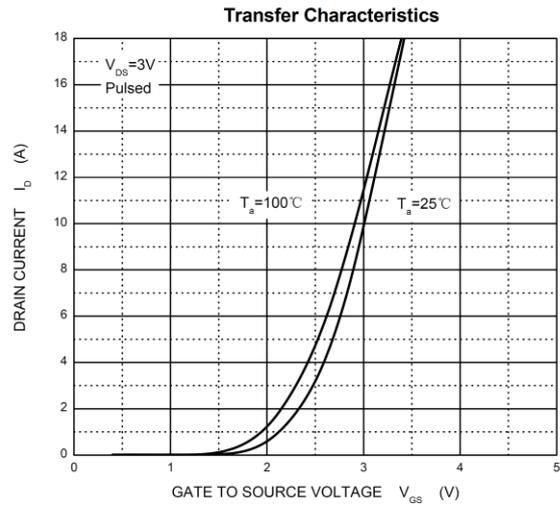
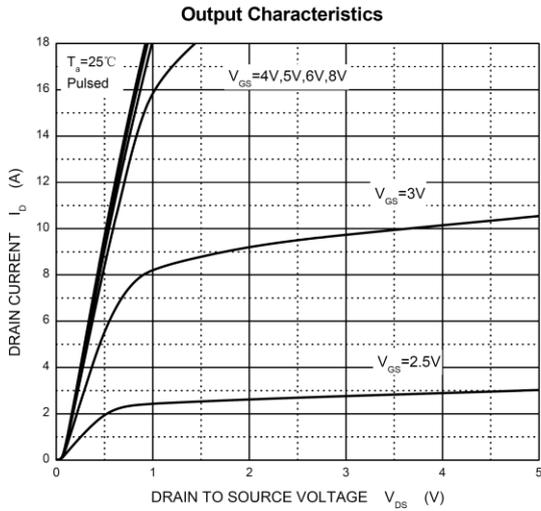
**MOSFET ELECTRICAL CHARACTERISTICS( $T_a=25^{\circ}\text{C}$  unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>STATIC CHARACTERISTICS</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 30V, V_{GS} = 0V$			1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$			$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1	1.5	3	V
Drain-source on-resistance <sup>(1)</sup>	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 5.8A$		21	30	m $\Omega$
		$V_{GS} = 4.5V, I_D = 4.8A$		28	42	
Forward tranconductance <sup>(1)</sup>	$g_{FS}$	$V_{DS} = 5V, I_D = 3.8A$	5			S
Body Diode Voltage	$V_{SD}$	$I_S = 1A, V_{GS} = 0V$			1	V
<b>DYNAMIC CHARACTERISTICS<sup>(2)</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$			810	pF
Output Capacitance	$C_{oss}$			115		
Reverse Transfer Capacitance	$C_{rss}$			83		
Gate resistance	$R_g$	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$			1.5	$\Omega$
<b>SWITCHING CHARACTERISTICS<sup>(2)</sup></b>						
Turn-on delay time	$t_{d(on)}$	$V_{GS} = 10V, V_{DS} = 15V,$ $R_L = 2.6\Omega, R_{GEN} = 6\Omega$			6.4	ns
Turn-on rise time	$t_r$			3.1		
Turn-off delay time	$t_{d(off)}$			15.0		
Turn-off fall time	$t_f$			2.6		

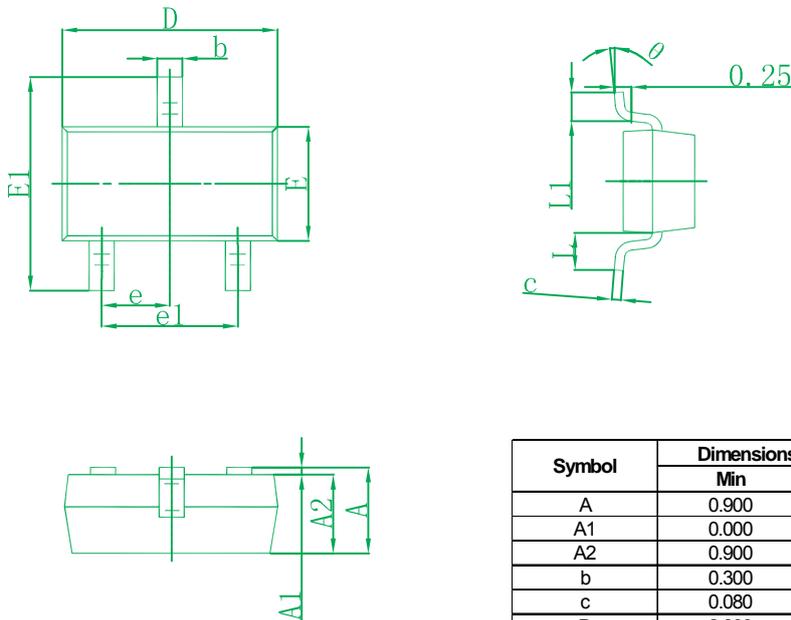
**Notes:**

1. Pulse Test : Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 0.5\%$ .
2. These parameters have no way to verify.

Typical Electrical and Thermal Characteristics

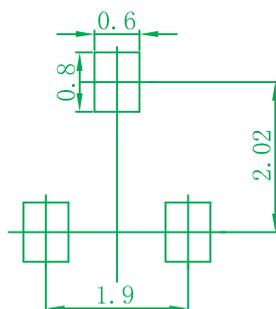


## SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.150	0.035	0.045
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.050	0.110	0.120
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.360 REF		0.014 REF	
θ	0°	8°	0°	8°

## SOT-23 Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
  2. General tolerance:  $\pm 0.05$  mm.
  3. The pad layout is for reference purposes only.

## Ordering information

Device	Package	Shipping
EP3404	SOT-23	3000/Tape&Reel(7inches)